

XENSIV™ TMR wheel speed sensor for magnetic encoder application

Features

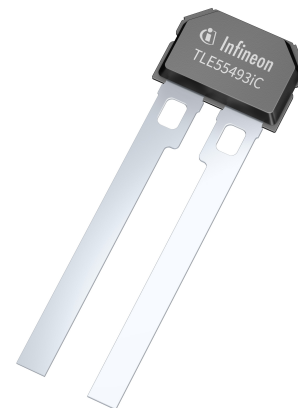
- High spatial resolution: up to 8 output protocols per magnetic period
- Valid and correct direction on first output protocol
- Enhanced digital algorithm ensures correct protocols even under mechanical vibration conditions
- Advanced stop-start capabilities including no loss of direction information
- Differential concept for robustness against external magnetic disturbance
- ISO 26262 safety element out of context for safety requirements up to ASIL D

Potential applications

- Anti-lock braking system
- Indirect tire pressure monitoring system
- Hill holder and electronic parking brake with high resolution
- Autonomous parking with high resolution

Product validation

Product validation according to AEC-Q100, Grade 0. Qualified for automotive applications.



Description

The TLE55493iC is a wheel speed sensor featuring high angular resolution and fast direction detection, designed for sophisticated vehicle control systems and autonomous parking applications.

The rotational speed is sensed with high accuracy for best in class jitter performance, enabling the sensor to be used as a component of indirect tire pressure monitoring systems (ITPMS). It is based on linearized TMR, providing a wide linear range and operating area. Thanks to the differential sensing principle, excellent robustness against external homogeneous magnetic field disturbances is achieved to support new requirements coming from electrification. Excellent sensitivity to magnetic field is specified over a wide temperature range to support a larger operating area. To meet harsh automotive requirements, robustness to electrostatic discharge (ESD) and electromagnetic compatibility (EMC) has been maximized without the need of additional external components.

Note

This document provides an extract of the full datasheet. A detailed version of the datasheet is available upon request through your Infineon regional representative.

Ordering information

Name	Marking	Ordering Code	Package
TLE55493iC-LR-6M	493X6C	SP005904502	PG-SSO-2-51
TLE55493iC-LR-8H	493X6D	SP005904506	PG-SSO-2-51

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1 Pin configuration and application circuit

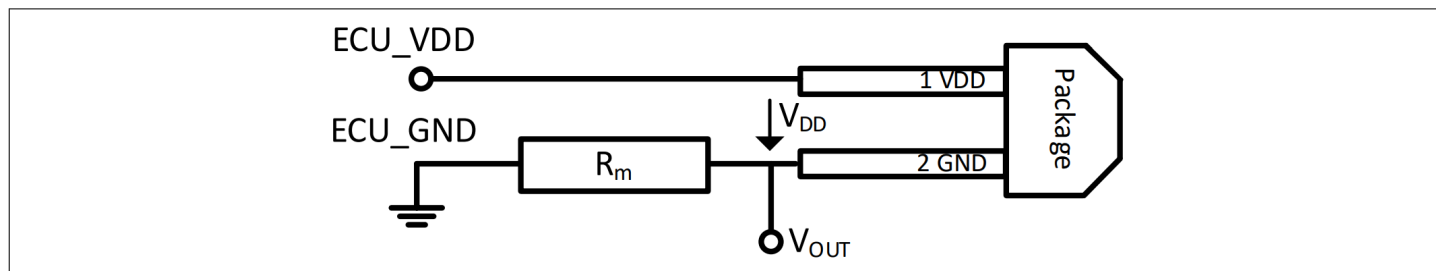


Figure 1 Application circuit example - load resistor (R_m) on GND pin

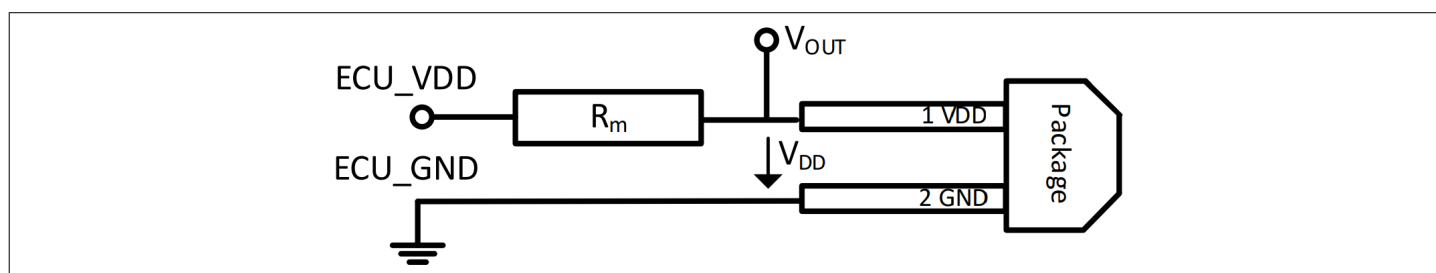


Figure 2 Application circuit example - load resistor (R_m) on V_{DD} pin

Pin No.	Symbol	Function
1	V_{DD}	Supply voltage
2	GND	Ground

2 Operating range

All parameters specified as parametric characteristics (see Table 2) refer to the below-listed operating conditions unless otherwise stated. The operating range does not specify technical requirements, but rather defines the boundary conditions of the requirements and their verification.

Table 1 Operating range

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
Electrical						
Supply voltage	V_{DD}	$3.5+V_{HYST}$	-	20	V	at sensor pins, $V_{HYST}=V_{DD_HYST}$
Load resistor	R_m	3	-	50	Ω	-
Application temperature mission profile						
Junction temperature	T_J	-40	-	110	$^{\circ}\text{C}$	either 12500 h
		-40	-	170	$^{\circ}\text{C}$	or 500 h
		-10	-	60	$^{\circ}\text{C}$	additional 30000 h (battery charging time)
Magnetical						
Magnetic signal frequency range	f_{MAG}	0	-	3000	Hz	Footnote ¹⁾
Magnetic signal frequency - high res. on	f_{HR_ON}	90	150	160	Hz	6M, Footnote ²⁾
		95	185	200	Hz	8H, Footnote ²⁾
Magnetic signal frequency - high res. off	f_{HR_OFF}	185	200	285	Hz	6M, Footnote ³⁾
		220	235	360	Hz	8H, Footnote ³⁾
Magnetic input signal at each sensing element	B_N	-29.1	-	29.1	mT	$T_J = 25^{\circ}\text{C}$, $B_N = \sqrt{(B_X^2+B_Y^2)}$
Differential input signal range in direction path	dB_{DR}	-20.0	-	20.0	mT	$T_J = 25^{\circ}\text{C}$
Limit threshold speed	dB_{LIMIT}	135	180	225	μT	$T_J = 25^{\circ}\text{C}$, Footnote ⁴⁾ ⁵⁾
Static homogeneous external disturbance field	B_{EXT_DC}	-5	0	5	mT	static field, same field at all sensing elements, Footnote ⁶⁾

- 1) Startup switching behavior to be considered especially at high speed.
- 2) Magnetic signal frequency range at which the sensor switches from normal resolution mode to high resolution mode.
- 3) Magnetic signal frequency range at which the sensor switches from high resolution mode to normal resolution mode.
- 4) Amplitude value, differential field.
- 5) No missing protocol while differential magnetic input is above max. dB_{LIMIT} . No protocol delivered while differential magnetic input is below min. dB_{LIMIT} . Verified with constant amplitude, constant offset and constant operating condition and at $f_{MAG} \geq 1\text{Hz}$.
- 6) Criterion: no additional/ missing protocols. Parametric characteristic valid only at typical value.

3 Parametric characteristics

The product characteristics are valid over the operating range. All values are specified for a sinusoidal signal with constant amplitude and offset, at constant operating conditions (i.e. wheel rotation direction, supply voltage, junction temperature). Typical values correspond to $V_{DD} = 12\text{ V}$ and $T_A = 25^\circ\text{C}$. Not all product characteristics are subject to production test, some are verified by design/characterization.

Table 2 Parametric characteristics

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
Period jitter on speed zero-crossing protocols						
Period jitter on speed zero-crossing protocols	S_{JIT_ZC}	-	-	0.15	%	$dB_{SP} > 2 \cdot dB_{LIMIT}, \pm 1\sigma$
Duty cycle of speed zero-crossing protocols						
Duty cycle of speed zero-crossing protocols	DC_{ZC}	45.0	-	55.0	%	$dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode
Duty cycle variation on consecutive zero-crossing protocols	DC_{VAR_ZC}	-	1	1.5	%	$dB_{SP} > 2 \cdot dB_{LIMIT}$, calibrated mode, Footnote ¹⁾
Period jitter on high-resolution protocols						
Period jitter on high resolution protocols	S_{JIT_HR}	-	-	1.10	%	$dB_{SP} > 4 \cdot dB_{LIMIT}, \pm 1\sigma$ value
Phase increment in high resolution						
Phase increment	φ_{INC}	$60 + \varphi$ ERR_MIN	60	$60 + \varphi$ ERR_MAX	$^\circ\text{mag}$	6M
		$45 + \varphi$ ERR_MIN	45	$45 + \varphi$ ERR_MAX	$^\circ\text{mag}$	8H
Phase error in high resolution						
Phase error	φ_{ERR}	-20.0	-	20.0	$^\circ\text{mag}$	calibrated mode, high resolution mode
Power-on and startup behavior						
Protocols required to have valid direction	n_{DIR}	-	-	0	-	Footnote ^{2) 3)}
Electrical						
Output current slew rate	SR_R SR_F	11	-	28	$\text{mA}/\mu\text{s}$	$SR_R = (I_{10\%} - I_{90\%}) / t_R, SR_F = (I_{90\%} - I_{10\%}) / t_F$, Footnote ⁴⁾
Failure indication current	I_{ERR}	0	2.2	3	mA	Footnote ⁵⁾
Output current during static output low state	I_{LOW}	6.2	7	7.8	mA	-
Output current during static output mid state	I_{MID}	12.6	14	15.4	mA	-

(table continues...)

3 Parametric characteristics

Table 2 (continued) Parametric characteristics

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
Output current during static output high state	I_{HIGH}	25.4	28	30.6	mA	-
Supply current ratio	I_{MID} / I_{LOW}	1.9	-	2.2	-	same temperature and same R_M for both current levels
	I_{HIGH} / I_{LOW}	3.8	-	4.5	-	same temperature and same R_M for both current levels
Line regulation	G_L	-	-	90	$\mu A/V$	dI/dV _{DD} , quasi static
Reset level	V_{DD_RESET}	-	-	3.5	V	-
Supply Hysteresis	V_{DD_HYST}	1.5	-	1.7	V	AK protocol

Thermal

Thermal resistance	R_{th}	-	120	190	K/W	junction-to-ambient, PG-SSO-2 package
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- 1) Variation between consecutive duty cycle values. Absolute value.
- 2) 1st protocol delivers valid and correct direction information.
- 3) 2nd protocol delivers valid and correct direction information in case of a temperature watchdog event triggered by sensor self-heating (change of T_J).
- 4) Valid for any current level transition, for any resistor value in the valid range and no external capacitor.
- 5) I_{ERR} is a low current level implemented to signalize failures which might severely impact the sensor's functionality. For more details, please refer to the product-specific safety manual.

Table 3 Output protocol (AK)

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
AK bit time	t_P	40	43	46	μs	-
Standstill period	t_{STOP}	150	172.5	195	ms	6M
		127.5	150	172.5	ms	8H
Delay between magnetic event and output protocol	t_{DELAY}	58	65	72	μs	Footnote ¹⁾

- 1) Time between digital switching event (zero crossing or angle threshold) and rising edge of the first AK protocol pulse (t_P for bit stump + $t_P / 2$ for initial I_{LOW} state).

4 Functional description

The sensor features a magnetic sensing interface, which senses the magnetic field change generated by the movement of a magnetized encoder wheel, and detects its rotational direction. The sensing principle is based on linearized TMR, sensitive to the magnetic field in x-direction. In the following figure the typical placement of the TLE55493iC facing a magnetic encoder wheel is shown.

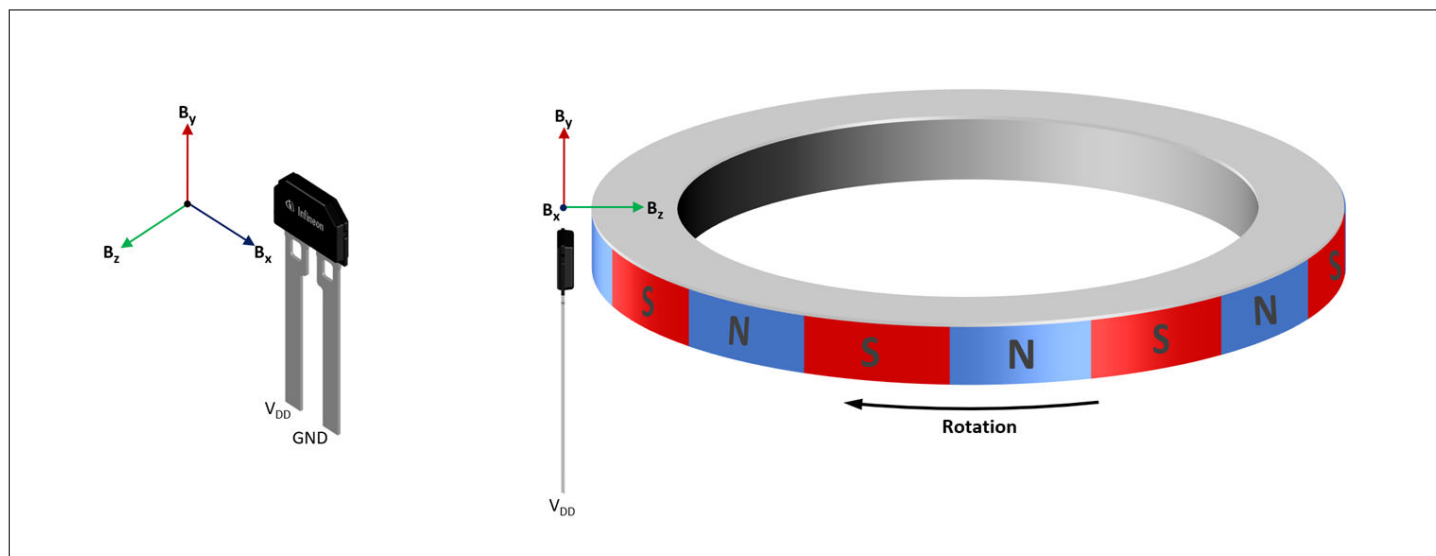


Figure 3 TLE55493iC coordinate system and typical mounting position in magnetic encoder applications

Note: $Y = 0$ mm refers to the $B_y = 0$ mT line of the magnetized stripe.

4.1 Undervoltage and power-on

The sensor implements an undervoltage comparator capable to trigger a reset signal when the supply voltage (i.e. V_{DD}) drops below the defined reset threshold V_{DD_RESET} .

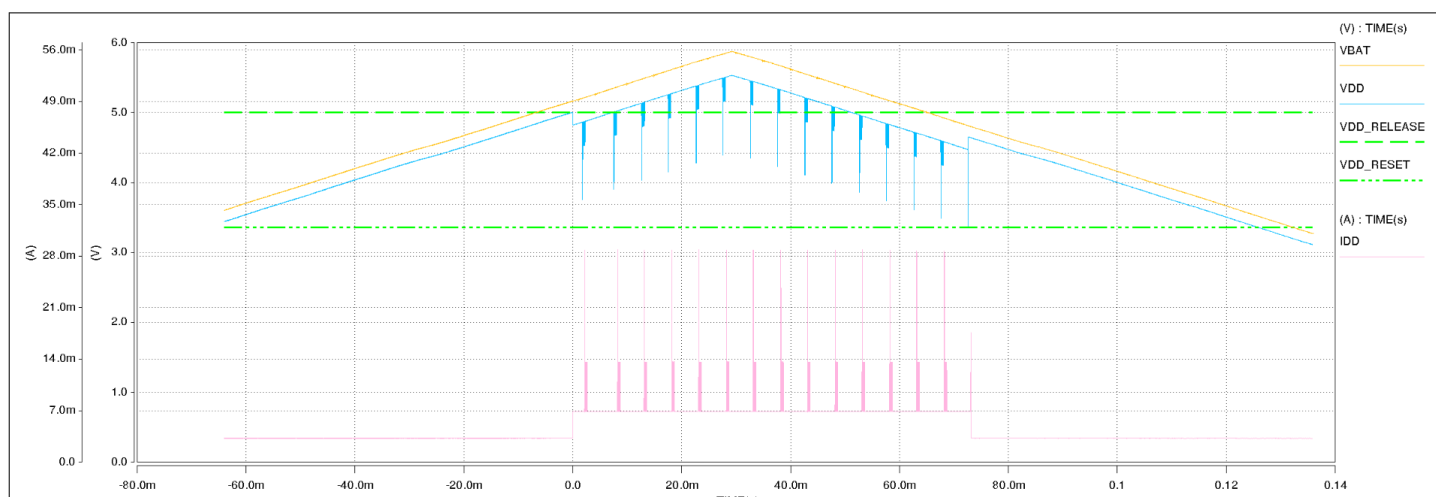


Figure 4 Undervoltage behavior

If V_{DD} drops below V_{DD_RESET} , then the sensor goes into reset state and reduces its current consumption down to I_{ERR} . If V_{DD} rises above V_{DD_MIN} level, then the sensor resumes the defined behavior within its power-on time.

$$V_{DD_RELEASE} = V_{DD_RESET} + V_{DD_HYST}$$

During the startup phase the current reaches the value of I_{ERR} before V_{DD} achieves $V_{DD_RELEASE}$.

4 Functional description

The initial current level for uncalibrated mode (I_{LOW}) is reached within the sensor power-on time and it fulfills the specified current limits as long as V_{DD} is above $V_{DD_RELEASE}$.

4.2 Output protocol (AK)

The AK output protocol is compliant to the document: "Requirement Specifications for Standardized Interface for Wheel Speed Sensors with Additional Information "AK-Protokoll" " Version: 4.0 13.02.2008 of Daimler AG, unless otherwise stated.

4.2.1 AK bits definition

4.2.1.1 AK-6M

Bits 0 - 8 are designated as data protocol and their purpose is to transfer additional information to the ECU. Bit #0 is used as an indication for air gap reserve (LR). Bit #1 (M), bit #3 (GDR), bit #4 (DR) and bit #8 (P) encode information regarding sensor calibration, validity of direction, direction of rotation and parity, respectively. Bit #2 (HR) is used to mark the high resolution protocols, while bits #5, #6, #7 encode information regarding the amplitude (LM0, LM1, LM2) or the angle (A0, A1, A2) of the magnetic field, depending on the type of protocol that is being sent. Zero-crossing protocols provide a first current pulse at I_{HIGH} level, while high resolution and standstill protocols provide a first current pulse at I_{MID} level.

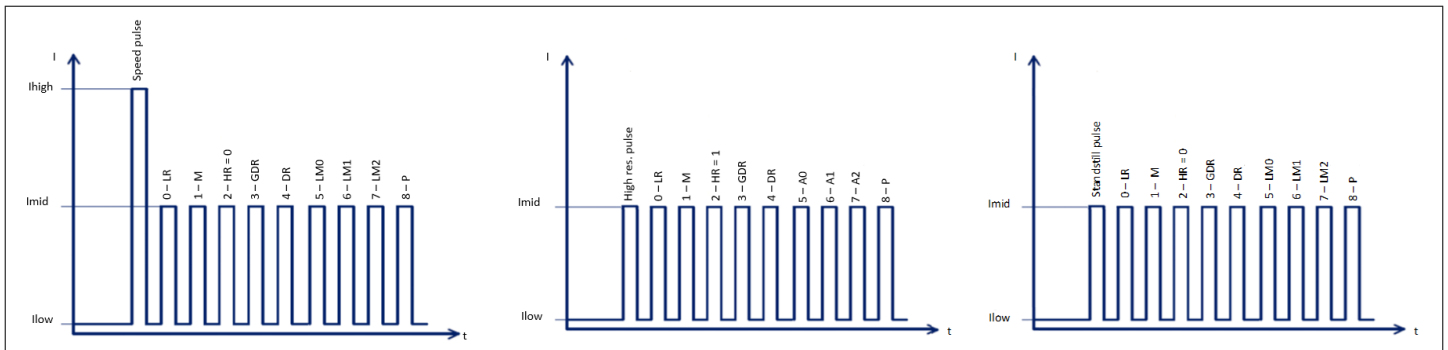


Figure 5 TLE55493iC-LR-6M bits encoding

4.2.1.2 AK-8H

Bits 0 - 8 are designated as data protocol and their purpose is to transfer additional information to the ECU. Bit #0 is used as an indication for air gap reserve (LR). Bit #1 (M), bit #3 (GDR), bit #4 (DR) and bit #8 (P) encode information regarding sensor calibration, validity of direction, direction of rotation and parity, respectively. Bit #2 (HR) is used to mark the high resolution protocols, while bits #5, #6, #7 encode information regarding the amplitude (LM0, LM1, LM2) or the angle (A0, A1, A2) of the magnetic field, depending on the type of protocol that is being sent. Zero-crossing and high-resolution protocols provide a first current pulse at I_{HIGH} level, while standstill protocols provide a first current pulse at I_{MID} level.

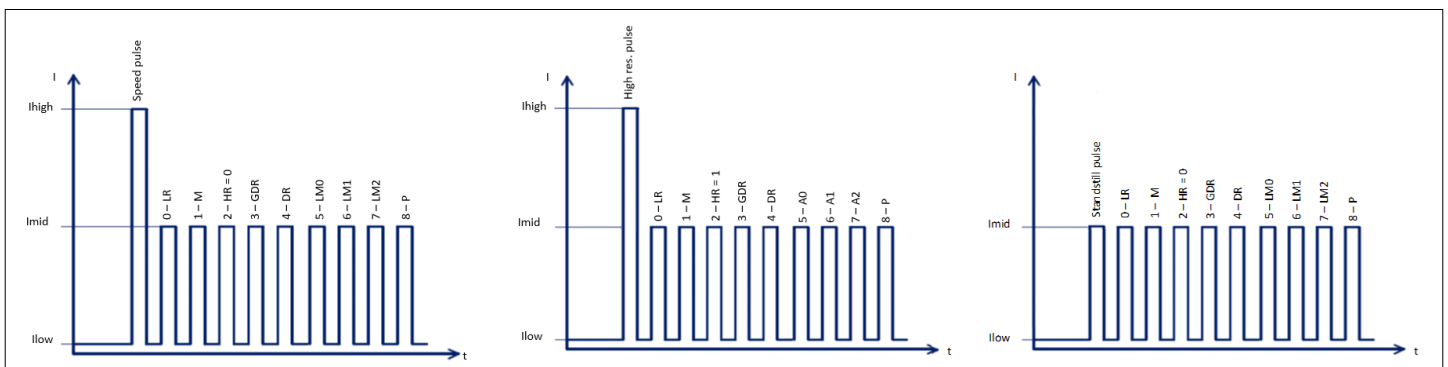


Figure 6 TLE55493iC-LR-8H bits encoding

4.2.1.3 LM bits encoding

The measured speed signal amplitude value is transmitted in the AK protocol using the LM bits. There is no hysteresis implemented for the calculation of the LM bits values. After power on the default value for LM is '000'. The speed signal amplitude is measured both in uncalibrated and calibrated mode. Nevertheless, LM values are valid only in calibrated mode, which is flagged by the M bit.

The relation between differential magnetic field and LM bits value is given in the following table.

Table 4 LM bits encoding

LM decimal	LM binary	Level in relation to dB_{LIMIT}
0	000	≤ 2
1	001	> 2
2	010	> 4
3	011	> 8
4	100	> 16
5	101	> 32
6	110	> 64
7	111	> 256

4.2.1.4 High resolution magnetic phase encoding

Table 5 High resolution magnetic phase encoding (6M)

#	Type of pulse	Phase in the magnetic signal	A2	A1	A0
1	Zero crossing pulse	0° (zero crossing)	-	-	-
2	High resolution pulse	60°	0	0	1
3	High resolution pulse	120°	0	1	0
5	Zero crossing pulse	180° (zero crossing)	-	-	-
6	High resolution pulse	240°	1	0	1
7	High resolution pulse	300°	1	1	0

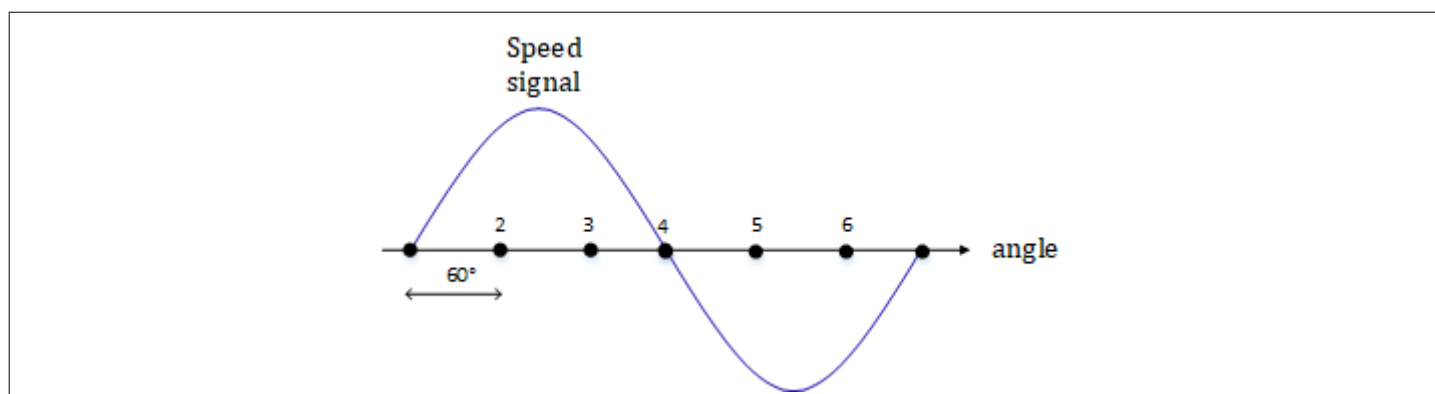


Figure 7 High resolution mode - switching points (6M)

Table 6 High resolution magnetic phase encoding (8H)

#	Type of pulse	Phase in the magnetic signal	A2	A1	A0
1	Zero crossing pulse	0° (zero crossing)	-	-	-
2	High resolution pulse	45°	0	0	1
3	High resolution pulse	90°	0	1	0
4	High resolution pulse	135°	0	1	1
5	Zero crossing pulse	180° (zero crossing)	-	-	-
6	High resolution pulse	225°	1	0	1
7	High resolution pulse	270°	1	1	0
8	High resolution pulse	315°	1	1	1

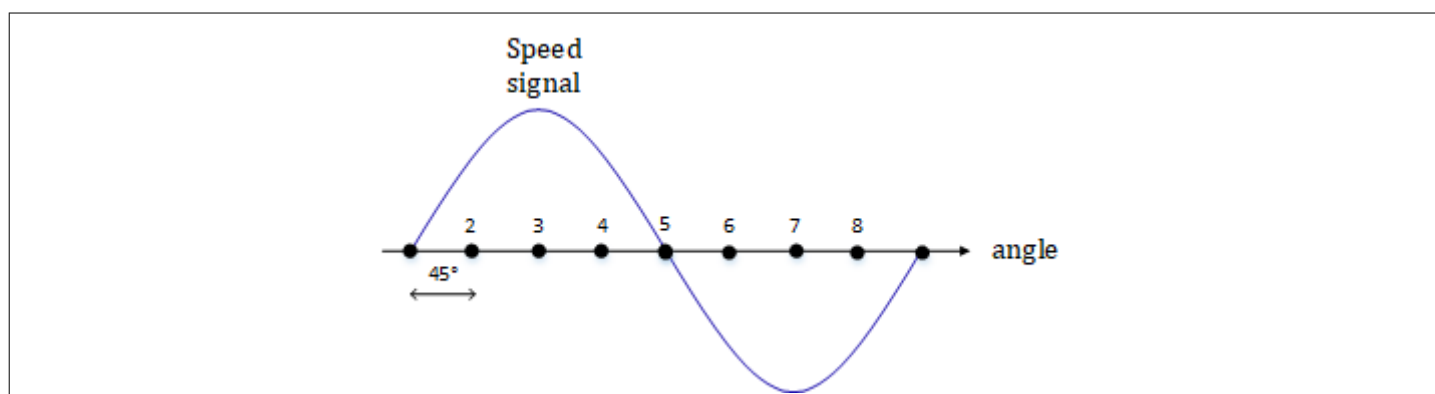


Figure 8 High resolution mode - switching points (8H)

4.2.2 Bit stomp suppression

The suppression of bit stumps in the Wheel Speed Sensor is required, so that the combination of sensors and ECUs from different manufacturers is as robust as possible. In this case, the sensor output is always completely shifted by a constant bit time when a new protocol start occurs. This is equivalent to a time output offset. The suppression of bit stumps is active in all speed ranges and in all operating states of the sensor.

5 ESD and EMC characteristics

EMC verification is performed based on standardized test methods under nominal environmental and operational conditions within typical application circuits, which are in detail documented within the test report. The procedure is consistent with Generic IC EMC Test Specification (BISS v2.1) and according ISO 26262 Part 5, Clause 10. EMC test pass/fail criteria are derived from product specifications, application requirements and top-level safety requirements. A defined relevant subset of the functional behavior and parameters of an IC is monitored during EMC tests. Observed deviations from the intended IC behavior are part of the test documentation. EMC requirements are not subject to production test and are verified by design and/or characterization based on typical samples from a typical lot. The characterization results will be assessed by technical experts and shared with the customer as a reference. Given the dependency of EMC performance on the integration on system level, it is the system integrators responsibility to ensure performance on system level.

Table 7 ESD characteristics

Parameter	Symbol	Values			Unit	Note or condition
		Min.	Typ.	Max.		
ESD HBM Voltage	V_{HBM}	-12	-	12	kV	Method AEC-Q100 -002 C=100pF, R=1500Ω

6 Package

The product is RoHS compliant (restriction of hazardous substances directive).

By following the application note "Recommendation for handling and assembly of Infineon PG-SSO Sensor Packages", the sensor terminals can be bent without causing incipient cracks influencing the sensor element function.

Please refer to your key account team or regional sales if you need further information.

Table 8 Package parameters

Parameter	Material
Lead Frame	CuCrSiTi (K75 UNS:C18070)
Lead Plating	Sn

The product is delivered in blister packing.

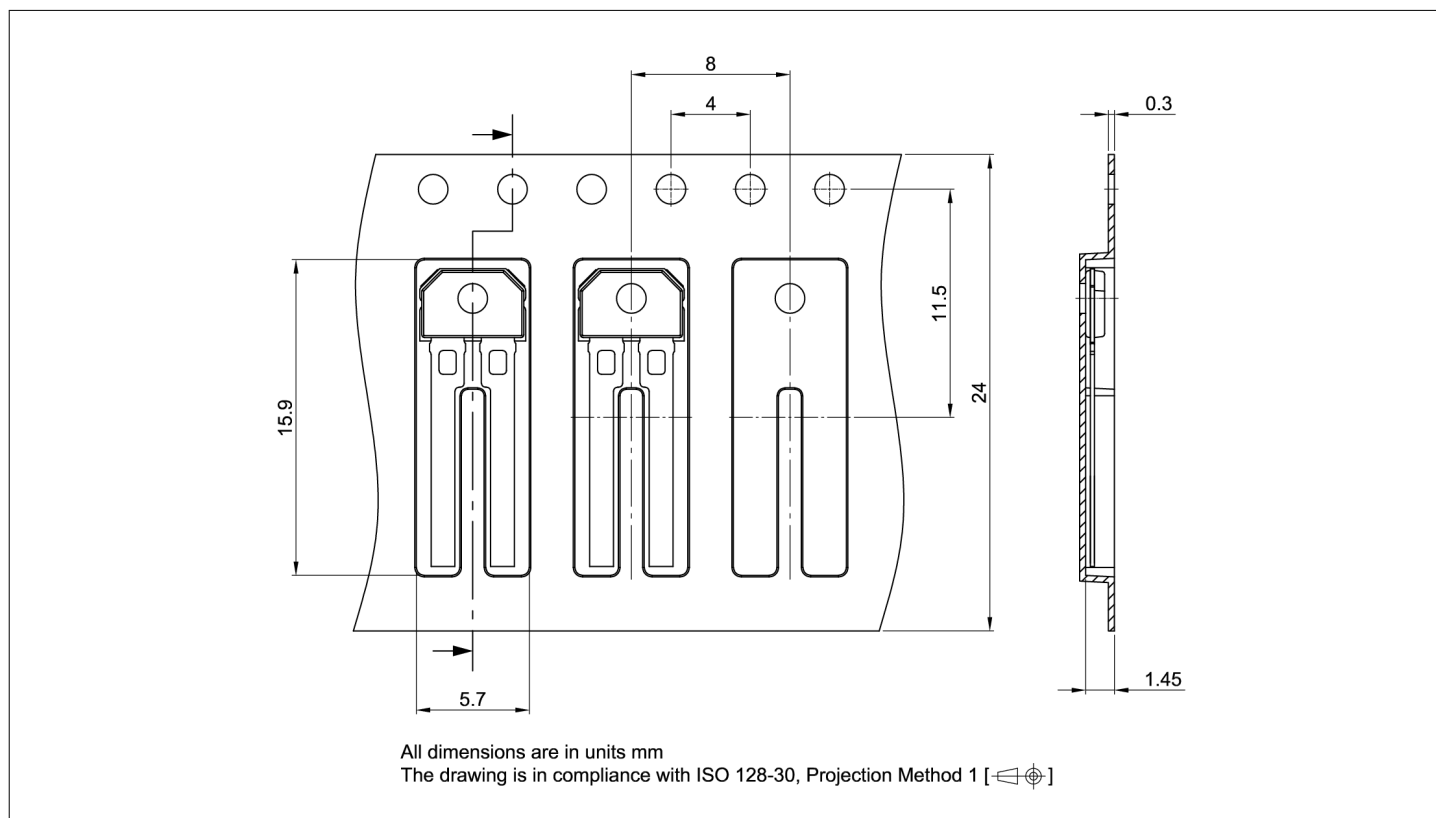


Figure 9 Packing dimensions of PG-SSO-2-51 in blister packing

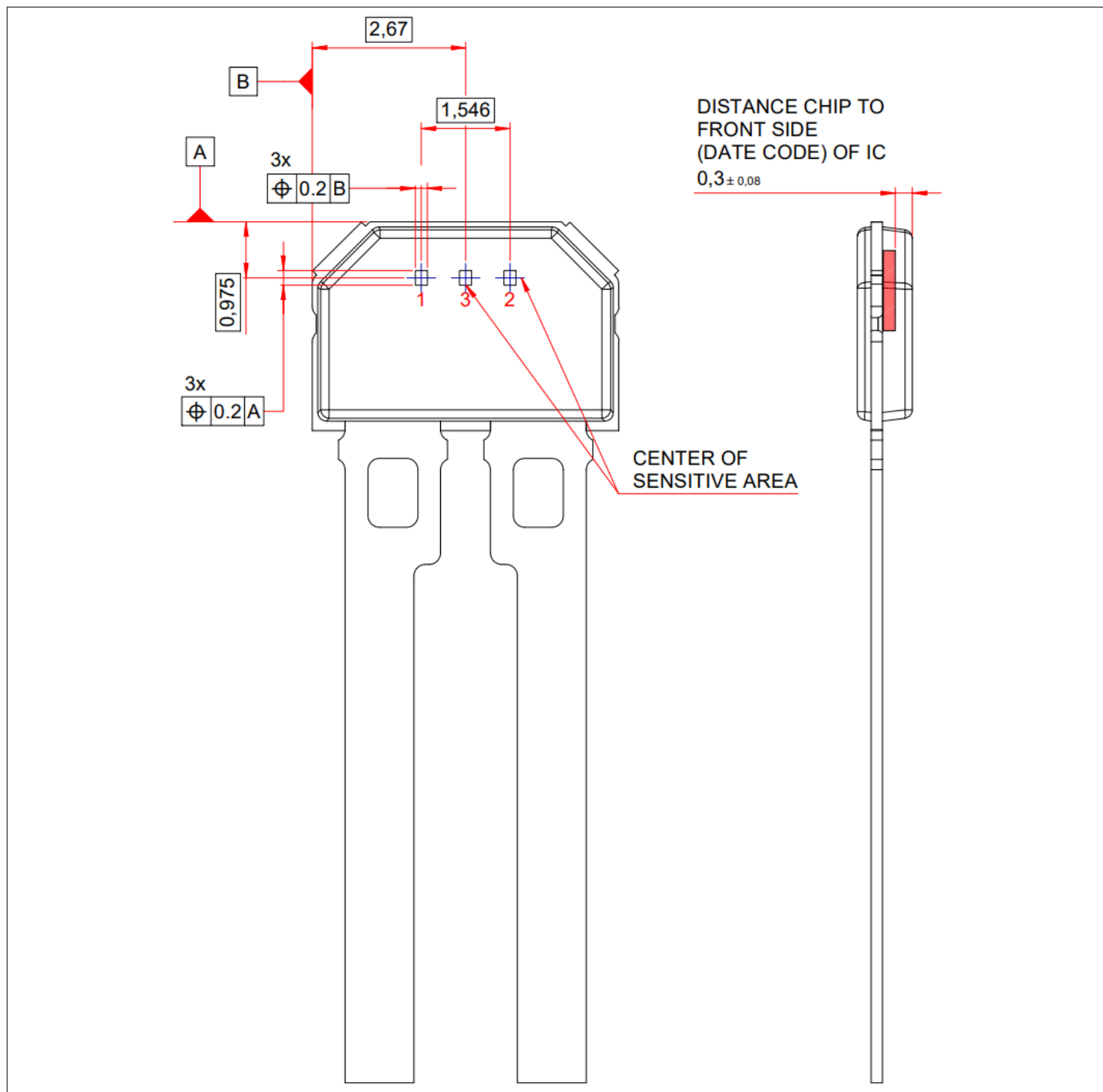


Figure 10 PG-SSO-2-51 package outline - sensing elements position details

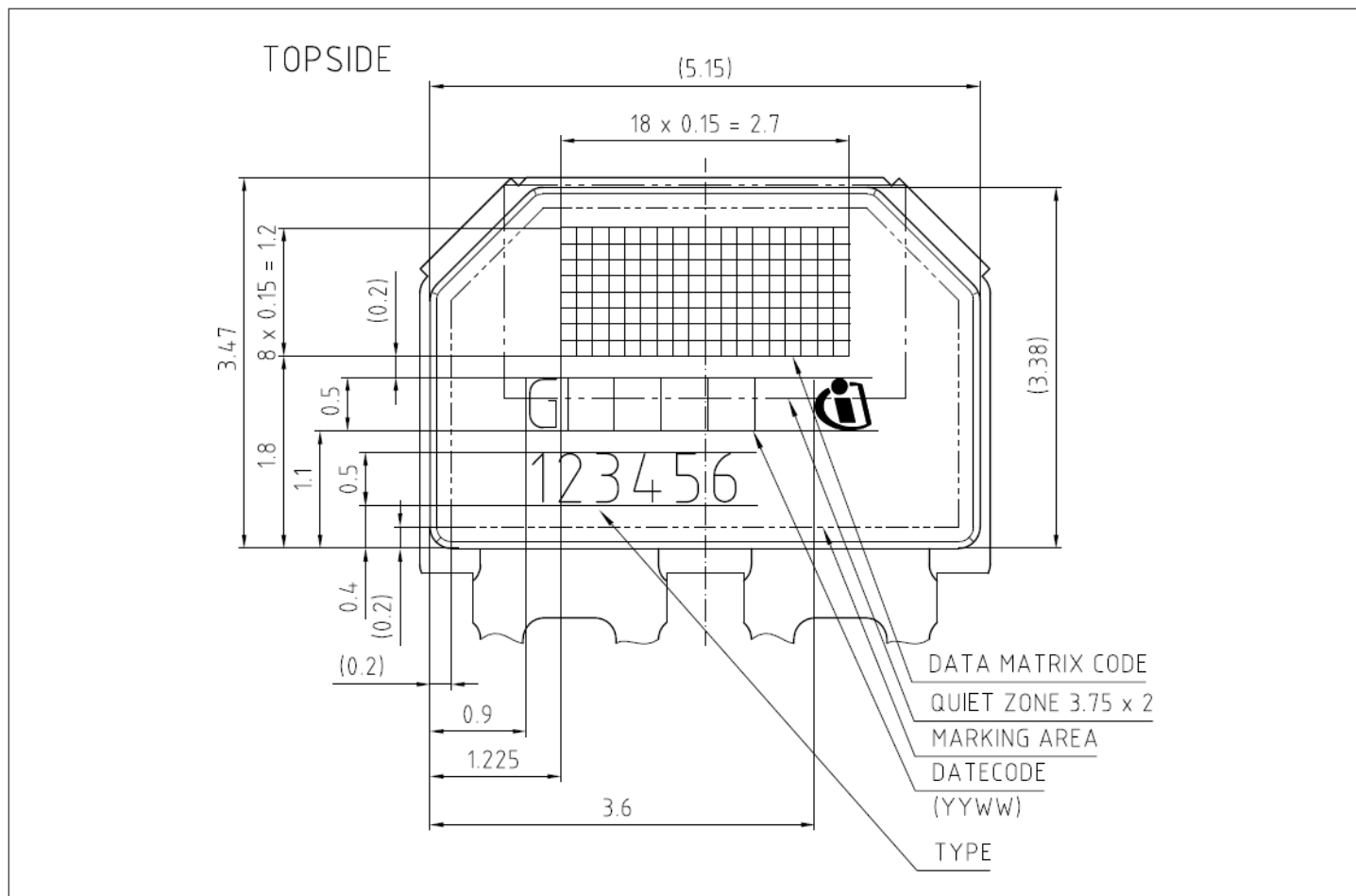


Figure 11 PG-SSO-2-51 marking

7 Revision history

Date	Version	Change Description
2026-01-22	1.00	Initial release

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